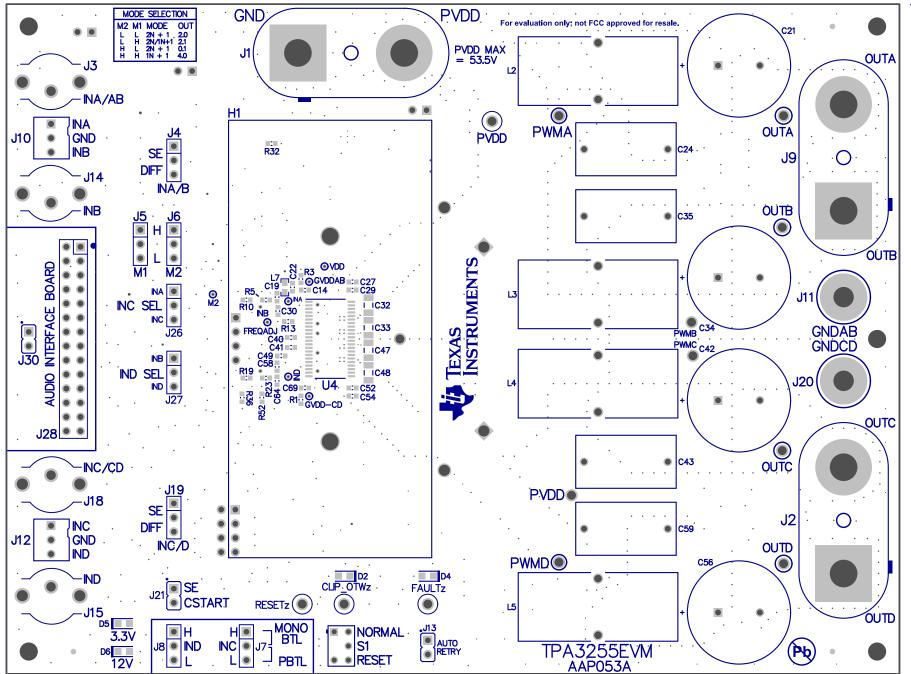
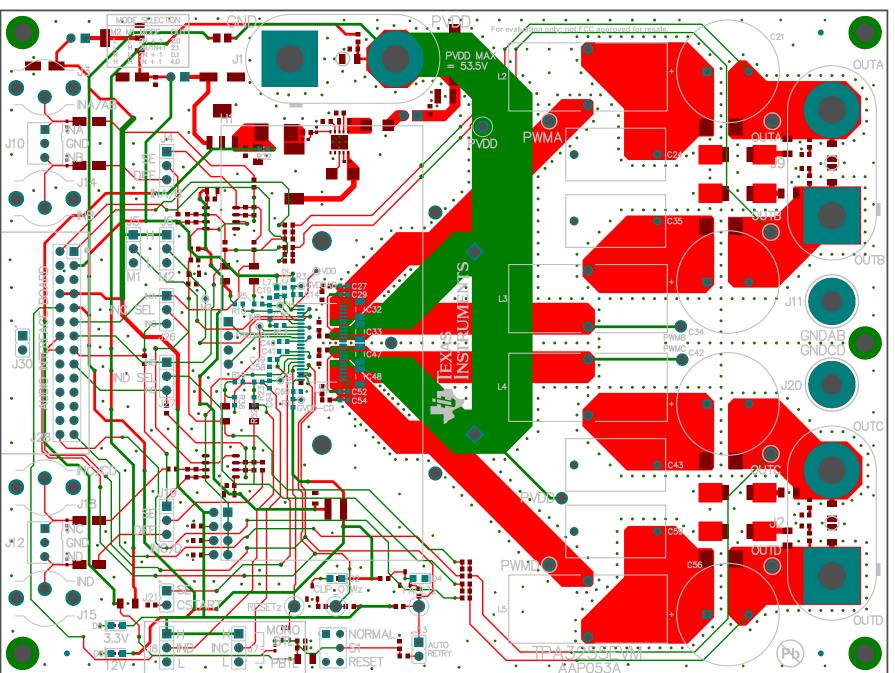


Top Overlay
Top Layer

Top Layer

Top Overlay

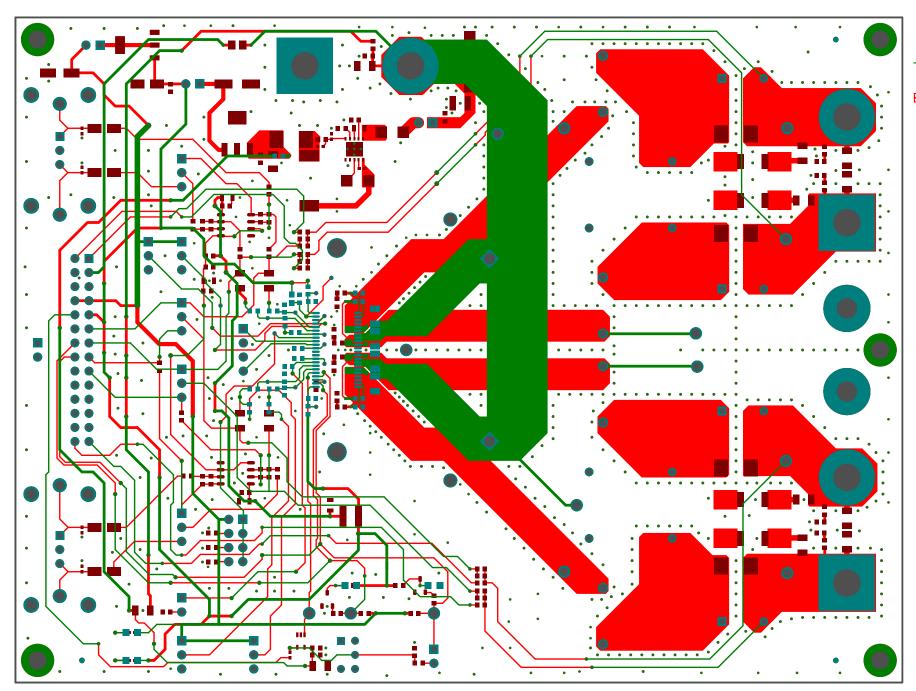




Top Overlay

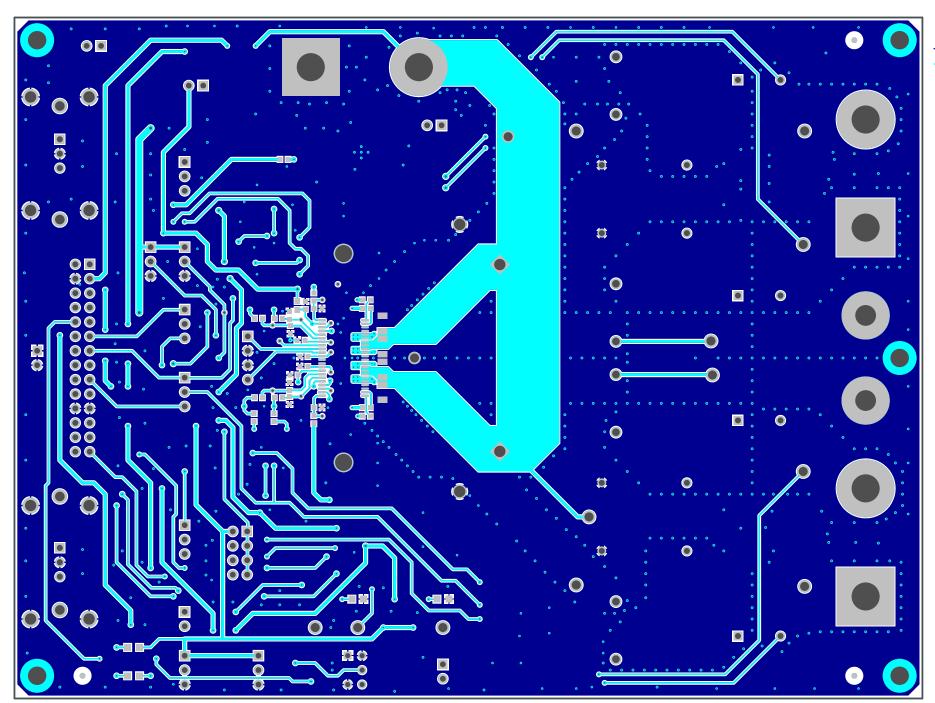
Top Layer

Bottom Layer

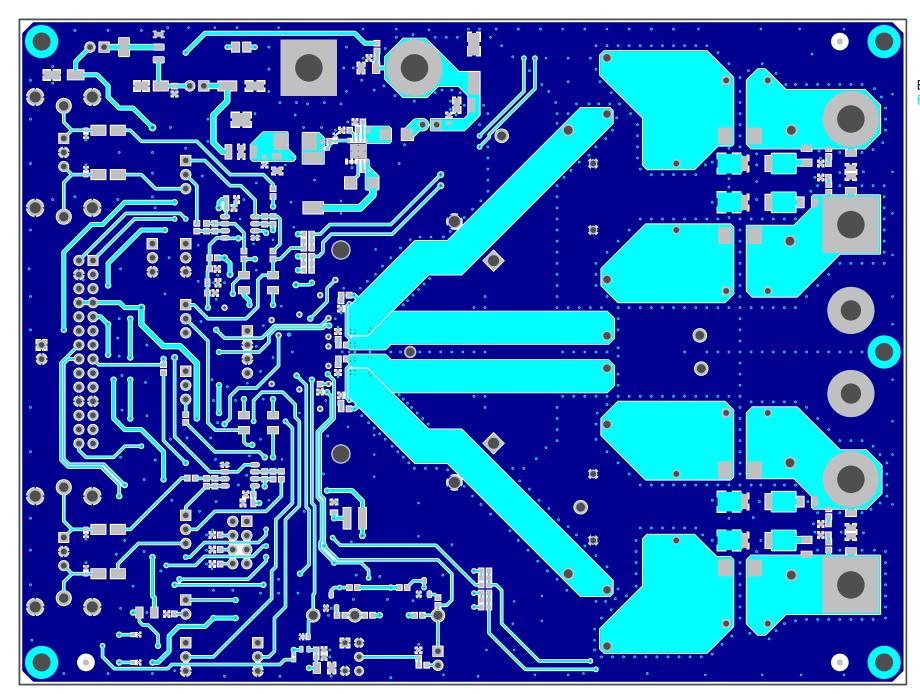


Top Layer

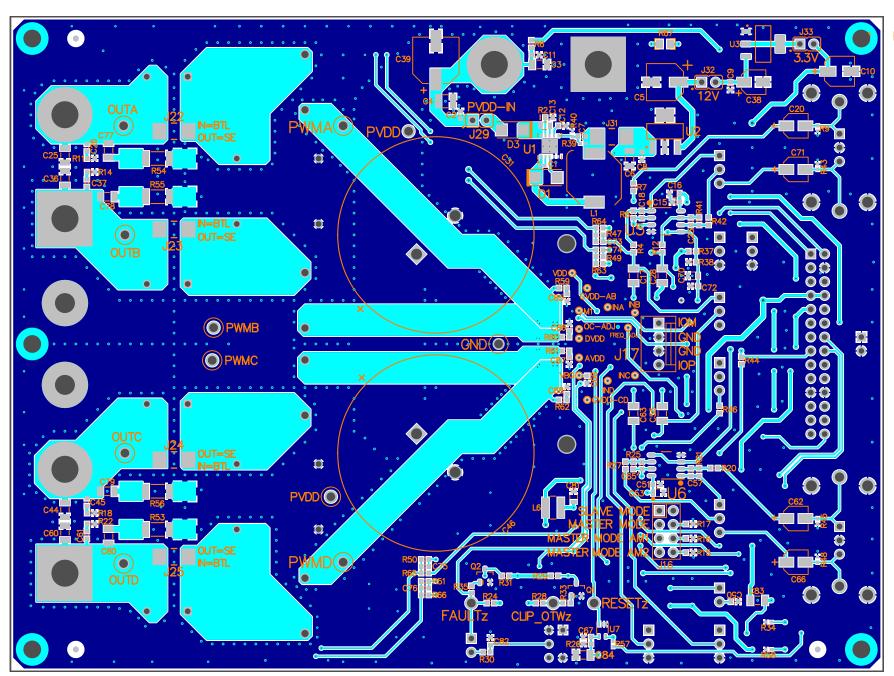
Bottom Layer



Top Layer Top Layer



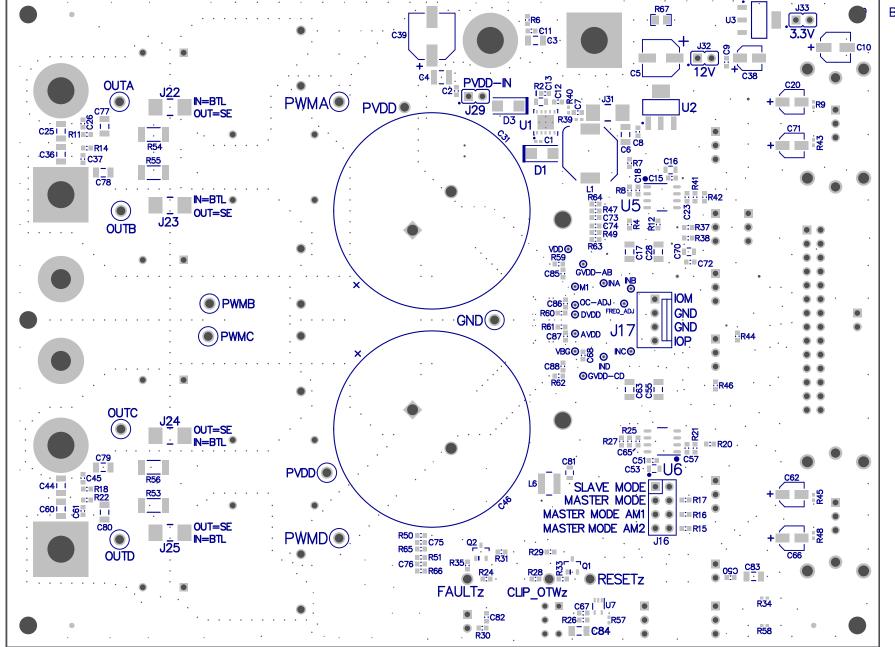
Bottom Layer Bottom Layer

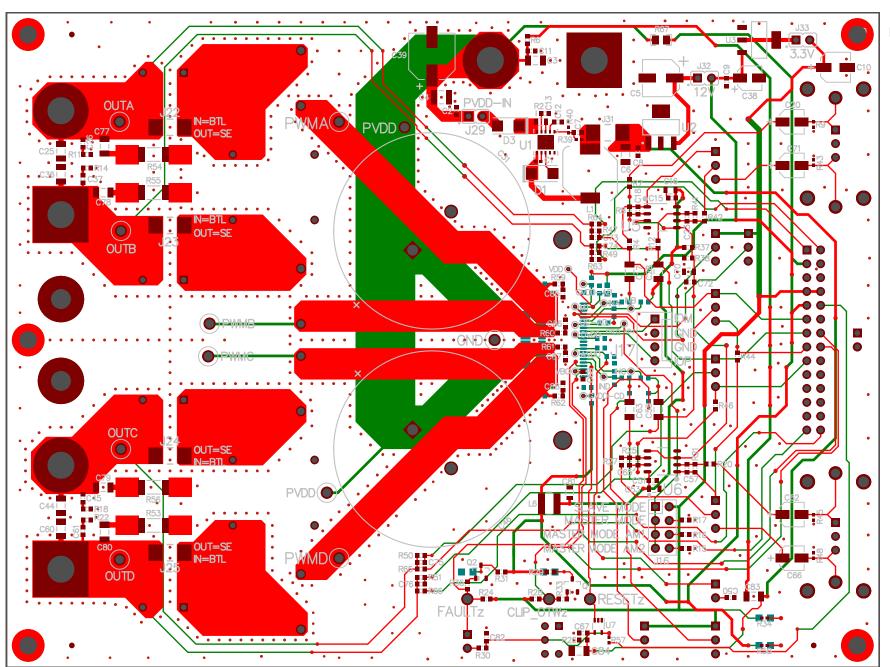


Bottom Overlay

Bottom Layer Bottom Layer

Bottom Overlay

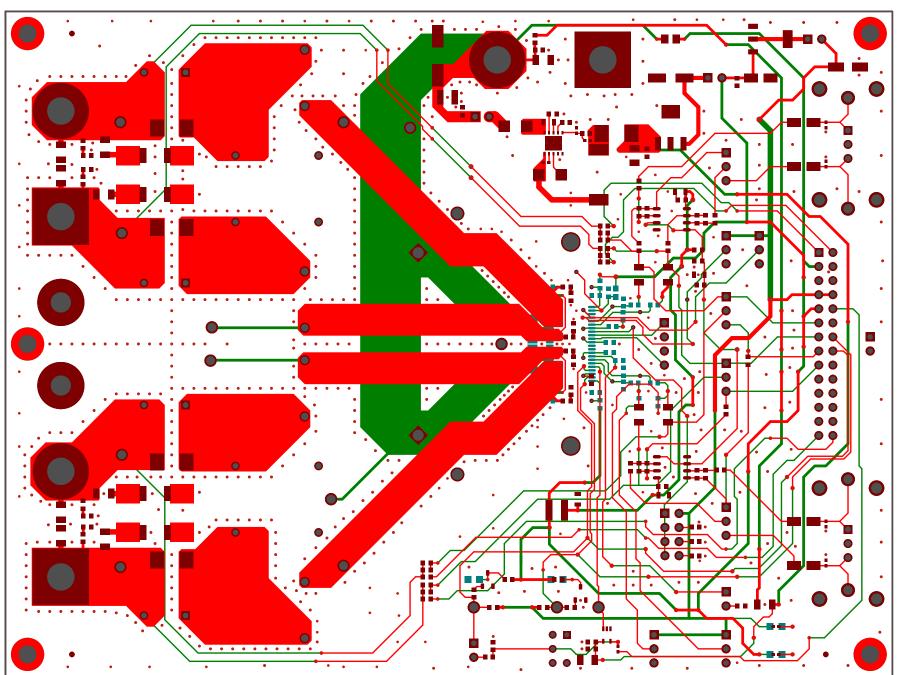




Bottom Overlay

Top Layer

Bottom Layer



Top Layer

Bottom Layer

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